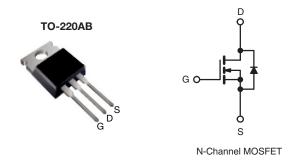
Vishay Siliconix

COMPLIANT

FREE

E Series Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V	0.28			
Q _g max. (nC)	78				
Q _{gs} (nC)	9				
Q _{gd} (nC)	17				
Configuration	Single				



FEATURES

- Low Figure-of-Merit (FOM) Ron x Qq
- Low Input Capacitance (Ciss)
- Reduced Switching and Conduction Losses
- Ultra Low Gate Charge (Q_q)
- Avalanche Energy Rated (UIS)
- Material categorization: For definitions of compliance please see <u>www.vishav.com/doc?99912</u>

APPLICATIONS

- Server and Telecom Power Supplies
- Switch Mode Power Supplies (SMPS)
- Power Factor Correction Power Supplies (PFC)
- Lighting
 - High-Intensity Discharge (HID)
 - Fluorescent Ballast Lighting
- Industrial
 - Welding
 - Induction Heating
 - Motor Drives
 - Battery Chargers
 - Renewable Energy
 - Solar (PV Inverters)

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	SiHP15N60E-E3			
Lead (Pb)-free and Halogen-free	SiHP15N60E-GE3			

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	600		
Gate-Source Voltage			V _{GS}	± 20	V	
Gate-Source Voltage AC (f > 1 Hz)				30		
Continuous Drain Current (T _J = 150 °C)	V_{GS} at 10 V $T_C =$	25 °C 100 °C	- I _D	15	А	
	VGS at 10 V	100 °C		9.6		
Pulsed Drain Current ^a			I _{DM}	39		
Linear Derating Factor				1.4	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	102	mJ	
Maximum Power Dissipation			P_D	180	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C	
Drain-Source Voltage Slope	T _J = 125 °C		dV/dt	37	V/ns	
Reverse Diode dV/dt ^d			uv/ut	7.7	V/IIS	
Soldering Recommendations (Peak Temperature) ^c for 10 s				300	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, $L = 11.6 \,^{\circ}\text{mH}$, $R_q = 25 \,^{\circ}\Omega$, $I_{AS} = 4.2 \,^{\circ}\Lambda$.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, dI/dt = 100 A/ μ s, starting $T_J = 25$ °C.



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.7	C/VV	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					L	L	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	Reference to 25 °C, I _D = 1 mA		0.71		V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2	-	4	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V		-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$		-	1 10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		-	0.23	0.28	Ω
Forward Transconductance	9 _{fs}	V _{DS}	s = 30 V, I _D = 8 A	-	4.6	-	S
Dynamic		^		•	ı	·	·
Input Capacitance	C _{iss}		$V_{GS} = 0 V$,	-	1350	-	
Output Capacitance	C _{oss}		$V_{DS} = 100 \text{ V},$	-	70	-	
Reverse Transfer Capacitance	C_{rss}		f = 1 MHz	-	5	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	53	-	pF
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	177	-	
Total Gate Charge	Qg				39	78	nC
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 8 \text{ A}, V_{DS} = 480 \text{ V}$		-	11	-	
Gate-Drain Charge	Q _{gd}			-	17	-	
Turn-On Delay Time	t _{d(on)}	V _{DD} = 480 V, I _D = 8 A,		-	16	32	ns
Rise Time	t _r			-	26	52	
Turn-Off Delay Time	t _{d(off)}		$V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		41	82	
Fall Time	t _f				22	44	
Gate Input Resistance	R_{g}	f = 1 MHz, open drain		-	0.86	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	15	A
Pulsed Diode Forward Current	I _{SM}			-	-	60	A
Diode Forward Voltage	V_{SD}	T _J = 25 °C, I _S = 8 A, V _{GS} = 0 V		-	1.0	1.2	V
Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 8 \text{ A},$ $dI/dt = 100 \text{ A/}\mu\text{s}, V_R = 25 \text{ V}$		-	302	604	ns
Reverse Recovery Charge	Q _{rr}			-	4.0	8	μC
Reverse Recovery Current	I _{RRM}			-	24	-	Α

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

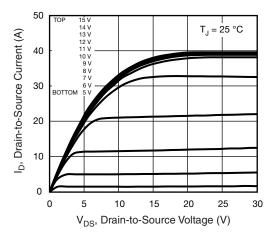


Fig. 1 - Typical Output Characteristics

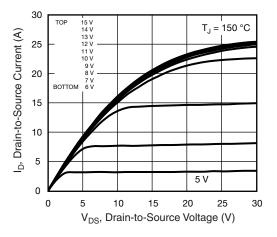


Fig. 2 - Typical Output Characteristics

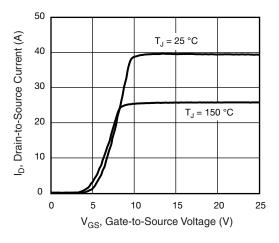


Fig. 3 - Typical Transfer Characteristics

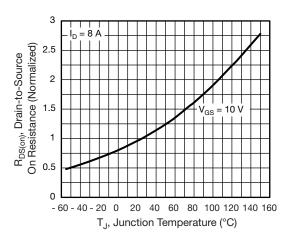


Fig. 4 - Normalized On-Resistance vs. Temperature

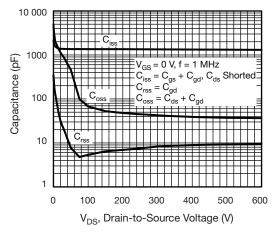


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

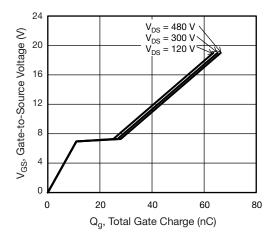


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



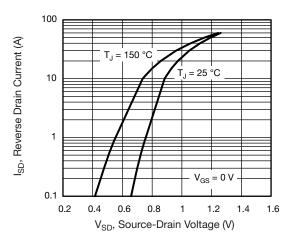


Fig. 7 - Typical Source-Drain Diode Forward Voltage

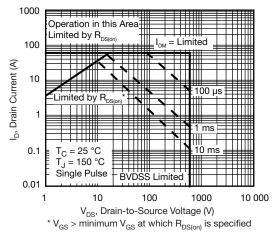


Fig. 8 - Maximum Safe Operating Area

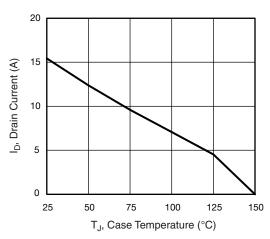


Fig. 9 - Maximum Drain Current vs. Case Temperature

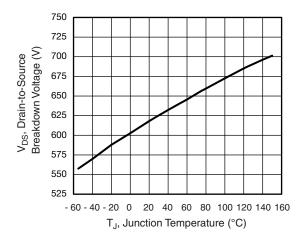


Fig. 10 - Temperature vs. Drain-to-Source Voltage

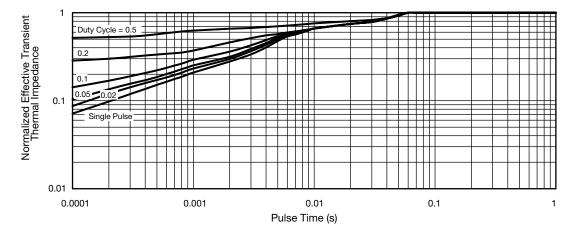


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



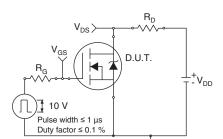


Fig. 12 - Switching Time Test Circuit

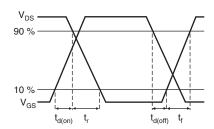


Fig. 13 - Switching Time Waveforms

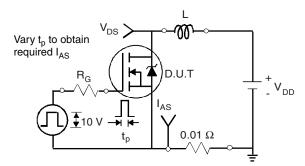


Fig. 14 - Unclamped Inductive Test Circuit

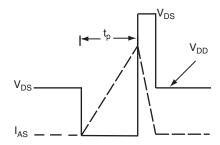


Fig. 15 - Unclamped Inductive Waveforms

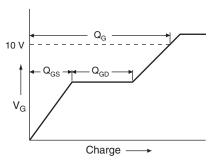


Fig. 16 - Basic Gate Charge Waveform

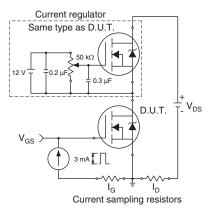
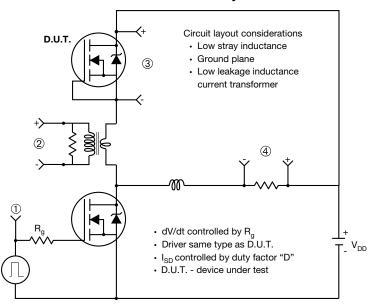


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



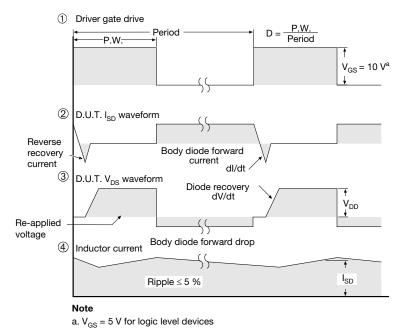


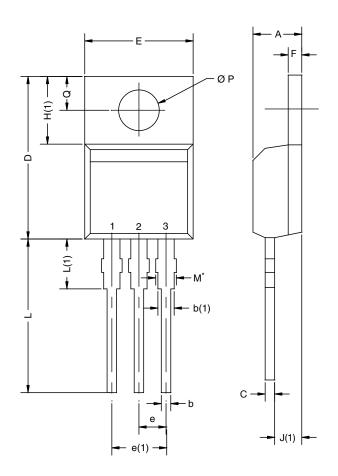
Fig. 18 - For N-Channel

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Vishay Siliconix

TO-220AB



	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØΡ	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
ECN: T13-0724-Rev. O, 14-Oct-13					

DWG: 5471

Note

 $^{^{\}star}$ M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

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Revision: 02-Oct-12 Document Number: 91000